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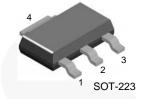
November 2014



BSP52 NPN Darlington Transistor

Description

This device is designed for applications requiring extremely high-current gain at collector currents to 500 mA. Sourced from process 03.



1. Base 2,4. Collector 3. Emitter

Ordering Information

Part Number	Marking	Package	Packing Method		
BSP52	BSP52	SOT-223 4L	Tape and Reel		

Absolute Maximum Ratings^{(1),(2)}

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at $T_A = 25^{\circ}$ C unless otherwise noted.

Symbol	Parameter	Value	Unit
V _{CES}	Collector-Emitter Voltage	80	V
V _{CBO}	Collector-Base Voltage	90	V
V _{EBO}	Emitter-Base Voltage	5	V
Ι _C	Collector Current - Continuous	800	mA
T _J , T _{STG}	Operating and Storage Junction Temperature Range	-55 to +150	°C

Notes:

- 1. These ratings are based on a maximum junction temperature of 150°C.
- 2. These are steady-state limits. Fairchild Semiconductor should be consulted on applications involving pulsed or low-duty-cycle operations.

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Thermal Characteristics⁽³⁾

Values are at $T_A = 25^{\circ}C$ unless otherwise noted.

Symbol	Parameter	Max.	Unit
Б	Total Device Dissipation	1000	mW
P _D	Derate Above 25°C	8.0	mW/°C
R _{θJA}	Thermal Resistance, Junction-to-Ambient	125	°C/W

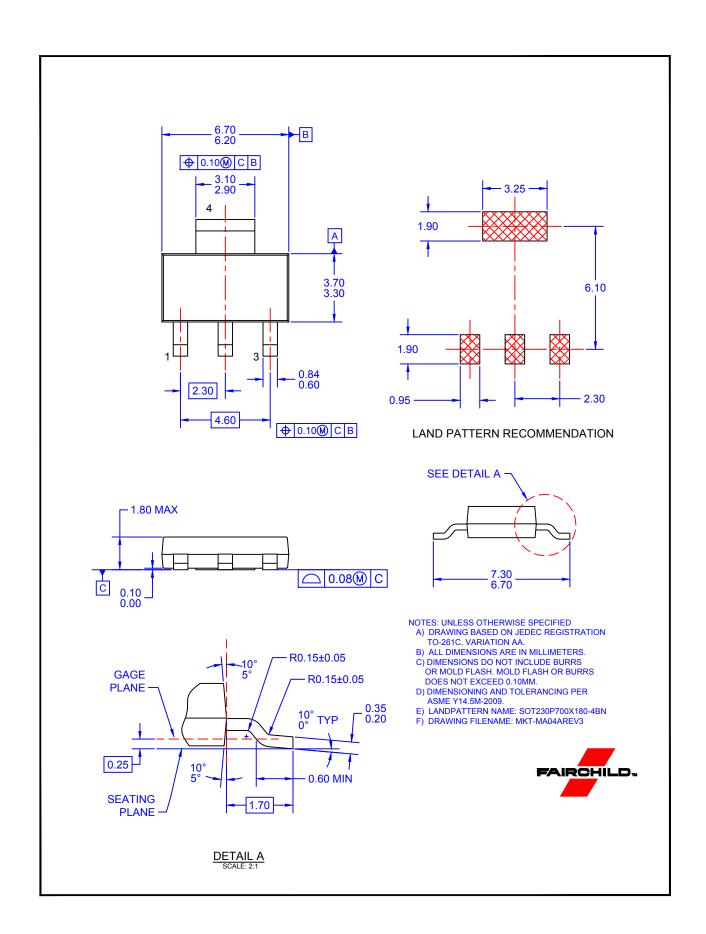
Note:

3. PCB size: FR-4, 76 mm x 114 mm x 1.57 mm (3.0 inch x 4.5 inch x 0.062 inch) with minimum land pattern size.

Electrical Characteristics

Values are at $T_A = 25^{\circ}C$ unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
V _{(BR)CBO}	Collector-Base Breakdown Voltage	$I_{C} = 100 \ \mu A, I_{E} = 0$	90			V
V _{(BR)EBO}	Emitter-Base Breakdown Voltage	$I_{E} = 10 \ \mu A, I_{C} = 0$	5			V
ICES	Collector Cut-Off Current	$V_{CE} = 80 \text{ V}, V_{BE} = 0$			10	μA
I _{EBO}	Emitter Cut-Off Current	$V_{EB} = 4.0 \text{ V}, I_{C} = 0$			10	μA
h	DC Current Gain	$I_{C} = 150 \text{ mA}, V_{CE} = 10 \text{ V}$	1000			
h _{FE}	De current Gam	I _C = 500 mA, V _{CE} = 10 V	2000			
V _{CE} (sat)	Collector-Emitter Saturation Voltage	$I_{\rm C} = 500 \text{ mA}, I_{\rm B} = 0.5 \text{ mA}$			1.3	V
V _{BE} (sat)	Base-Emitter Saturation Voltage	I _C = 500 mA, I _B = 0.5 mA			1.9	V



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